

CMOS general purpose timer

Features

- Exact equivalent in most cases for SE/NE555.
- Low Supply Current.
- High speed operation 500 kHz guaranteed.
- Wide operation supply voltage range 2 to 18 volts.
- Timing from microseconds through hours.
- Operates in both astable and monostable modes.
- Adjustable duty cycle.
- High output source/sink driver can drive TTL/CMOS



Ordering Information

DEVICE	Package Type	MARKING	Packing	Packing Qty
HGC555IN	DIP-8	HGC555I	TUBE	2000pcs/box
HGC555IM/TR	SOP-8	HGC555I	REEL	2500pcs/reel
HGC555IMM/TR	MSOP-8	C555I	REEL	3000pcs/reel



General Description

The HGC555 is CMOS RC timers providing significantly improved performance over the standard SE/NE555 and 355 timers, while at the same time being direct replacements for those devices in most applications. Improved parameters include low supply current, wide operating supply voltage range, low THRESHOLD, TRIGGER and RESET currents, no crowbarring of the supply current during output transitions, higher frequency performance and no requirement to decouple CONTROL VOLTAGE for stable operation.

Specifically, the HGC555 is stable controller capable of producing accurate time delays of frequencies.

Pin Assignment



Truth Table

THRESHOLD	TRIGGER	RESET	OUTPUT	DISCHARGE
Х	X	L	L	ON
> 2/3 V _{CC}	> 1/3 V _{CC}	Н	L	ON
< 2/3 V _{CC}	> 1/3 V _{CC}	Н	STABLE	STABLE
Х	< 1/3 V _{CC}	Н	Н	OFF



Maximum Ratings And Recommended Operating Conditions

		Recomm operatingc	nended onditions	Maximum ratings		
Parameter, unit	Symbol	Valu	ue	Val	ue	
		min	max	min	max	
Supply Voltage, V	Vcc	2.0	18.0	0	18.0	
Output Current, mA	lo	-	20	-	100	
Input Voltage, V	VTH, VTRIG, VRST	-	-	-0.3	V _{CC} +0.3	
Power Dissipation, mW	P _D	-	-	-	200	
Operating Temperature,°C	TOPR	-40	85	-40	85	
Storage Temperature,°C	TSTG	-	-	-65	150	
Lead Temperature, 1 mm from Case for 10 Seconds,°C	TSOLDER	-	-		245	

Note:Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured.



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HGC555

		Test Condit	ions	Val	Value		
Parameter, units	Symbol	IOL, IOH	VCC, B	min	max	rature, °C	
	\/		5.0	0.65 V _{cc}	0.70 V _{CC}	25±10	
I nresnoid voitage, v	VIH		5.0	0.60 V _{CC}	0.80 V _{CC}	-20, 70	
Trigger veltage V	VTRIC		5.0	0.31 V _{CC}	0.36 V _{CC}	25±10	
			5.0	0.28 V _{CC}	$0.40 V_{CC}$	-20, 70	
			2.0	0.4	1.0	25 ± 10	
Reset voltage V	VRST		18.0	0.4	1.0	25 - 10	
			2.0	0.2	15	-20 70	
			18.0	0.2	1.0	20, 70	
Control Voltage Lead V	VCV			0.65 V _{CC}	0.69 V _{CC}	25 10	
Control Voltage Lead, V				0.60 V _{CC}	0.80 V _{CC}	-20, 70	
	VOL	I _{OL} = 3.2 mA	5.0		0.4	25+10	
Output voltage Low V		I _{OL} = 20 mA	15.0		1.0	20 ± 10	
		I _{OL} = 3.2 mA	5.0		0.6	-20 70	
		I _{OL} = 20 mA	15.0		1.5	-20, 70	
			5.0	4.0		25 + 10	
Output voltage High V	Vон	$l_{ou} = -0.8 \text{ mA}$	15.0	14.3		25 - 10	
	•011	10H0.0 MA	5.0	3.5		-20 70	
			15.0	14.0		-20, 70	
			2.0		200	25+10	
Supply Current uA			18.0		300	20 - 10	
	.00		2.0		400	-20 70	
			18.0		600	-20,70	



Ac Electrical Characteristics

		Test Conditions	Va	Tempe-		
Parameter, unit	Symbol	R_L, C_L	VCC, V	Min	Max	rature, °C
Rise (Fall) Time of	tTHL,	$R_{L} = 10 \text{ M}$, $C_{L} = 10 \text{ pF}$	5.0	35	75	25±10
Output, ns	ιιμ			70	150	-20, 70
Guaranteed Max	fMAX	Astable Operation	2.0-	500		25±10
Osc Freq,kHz		- 1	18.0	200		-20, 70
Initial accuracy, %				5		
Drift with Tomporature			5.0		0.02	
%/°C	f	R∟ = 1 - 100 k	10.0		0.03	-20, 70
		C∟= 0.1 µF	15.0		0.06	
Drift with Supply Voltage,	f		5.0		3	25 ± 10
%/B			5.0		6	-20, 70



Figura 1. Block Diagram



Figura 2. Switcing Waveforms



Physical Dimensions

SOP-8





Dimensions In Millimeters(SOP-8)									
Symbol:	А	A1	В	С	C1	D	Q	а	b
Min:	1.35	0.05	4.90	5.80	3.80	0.40	0°	0.35	1 07 860
Max:	1.55	0.20	5.10	6.20	4.00	0.80	8°	0.45	1.27 030

DIP-8







Dimensions In Millimeters(DIP-8)											
Symbol:	A	В	D	D1	Е	L	L1	а	b	с	d
Min:	6.10	9.00	8.10	7.42	3.10	0.50	3.00	1.50	0.85	0.40	2 54 860
Max:	6.68	9.50	10.9	7.82	3.55	0.70	3.60	1.55	0.90	0.50	2.94 BSC



Physical Dimensions

MSOP-8



Dimensions In Millimeters(MSOP-8)									
Symbol:	A	A1	В	С	C1	D	Q	а	b
Min:	0.80	0.05	2.90	4.75	2.90	0.35	0°	0.25	
Max:	0.90	0.20	3.10	5.05	3.10	0.75	8°	0.35	0.05 650



Revision History

DATE	REVISION	PAGE
2019-3-6	New	1-9
2023-9-13	Update encapsulation type , Update Lead Temperature 、 Updated DIP-8 dimension、Add annotation for Maximum Ratings、Update Ordering Information	1、3、6



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